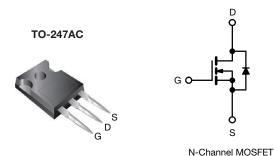
SiHG44N65EF

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Vishay Siliconix

E Series Power MOSFET with Fast Body Diode



FEATURES

- Fast body diode MOSFET using E series technology
- Reduced $t_{rr},\,Q_{rr},\,and\,I_{RRM}$
- Low figure-of-merit (FOM): Ron x Qg
- Low input capacitance (C_{iss})
- Low switching losses due to reduced Q_{rr}
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High intensity discharge (HID)
 - Light emitting diodes (LEDs)
- Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
 - Battery chargers
- Renewable energy
 Solar (PV inverters)
- Switch mode power supplies (SMPS)
- Applications using the following topologies
 - LLC
 - Phase shifted bridge (ZVS)
 - 3-level inverter
 - AC/DC bridge

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free and halogen-free	SiHG44N65EF-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 ^{\circ}C$, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	650	v			
Gate-source voltage			V _{GS}			± 30	
Continuous drain current (T_J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	I	46			
	V _{GS} at 10 V	T _C = 100 °C	I _D	29	А		
Pulsed drain current ^a			I _{DM}	154			
Linear derating factor			3.3	W/°C			
Single pulse avalanche energy ^b		E _{AS}	596	mJ			
Maximum power dissipation		PD	417	W			
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C			
Drain-source voltage slope	T _J = 125 °C		alı ı /alt	70			
Reverse diode dv/dt d		dv/dt	50	V/ns			
Soldering recommendations (peak temperature) ^c	for 10 s			300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 6.5 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 110 A/µs, starting T_J = 25 °C

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	-	40	°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	0.3	0,0	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static				•	•		
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA		650	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 10 mA	-	0.75	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-source leakage	I _{GSS}	V _{GS} = ± 20 V		-	-	± 100	nA
			V _{GS} = ± 30 V	-	-	± 1	μA
		V _{DS} =	: 520 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 520 V	V _{DS} = 520 V, V _{GS} = 0 V, T _J = 125 °C		-	500	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 22 A	-	0.063	0.073	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} = 30 V, I _D = 22 A		-	17	-	S
Dynamic				•	•		•
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	5892	-	pF
Output capacitance	Coss			-	244	-	
Reverse transfer capacitance	C _{rss}			-	4	-	
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{\rm GS}$ = 0 V, $V_{\rm DS}$ = 0 V to 520 V		-	178	-	
Effective output capacitance, time related b	C _{o(tr)}			-	739	-	
Total gate charge	Qg			-	185	278	nC
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 22 \text{ A}, V_{DS} = 520 \text{ V}$	-	46	-	
Gate-drain charge	Q _{gd}				76	-	1
Turn-on delay time	t _{d(on)}	$V_{DD} = 520 \text{ V}, \text{ I}_{D} = 22 \text{ A}$ $\text{R}_{g} = 9.1 \Omega, \text{ V}_{\text{GS}} = 10 \text{ V}$		-	46	92	ns
Rise time	t _r			-	77	116	
Turn-off delay time	t _{d(off)}			-	157	236	
Fall time	t _f			-	100	150	
Gate input resistance	R _g	f = 1 MHz, open drain		0.2	0.5	1.0	Ω
Drain-Source Body Diode Characteristics					•		
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	46	- A
Pulsed diode forward current	I _{SM}			-	-	154	
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 22 A, V _{GS} = 0 V		-	0.9	1.2	V
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 22 \text{ A},$ di/dt = 100 A/ μ s, V _R = 400 V		-	245	404	ns
Reverse recovery charge	Q _{rr}			-	2.2	3.0	μC
Reverse recovery current	I _{RRM}			-	26	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

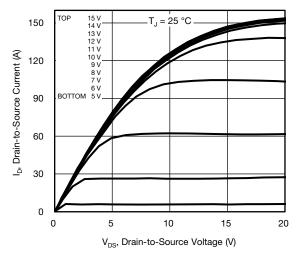
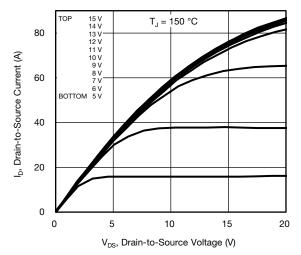
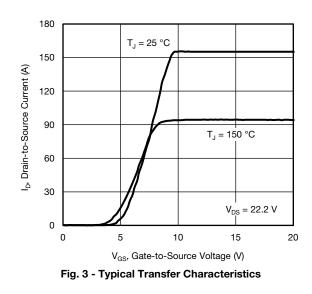


Fig. 1 - Typical Output Characteristics







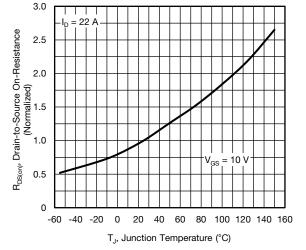


Fig. 4 - Normalized On-Resistance vs. Temperature

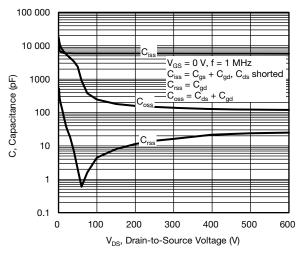
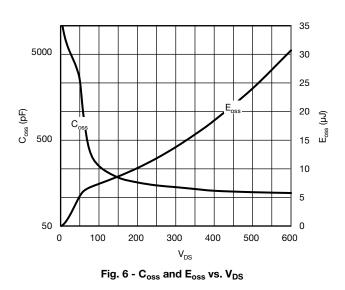


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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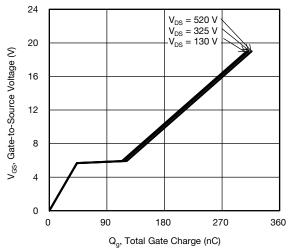


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

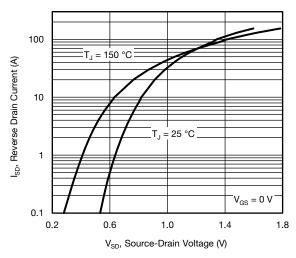
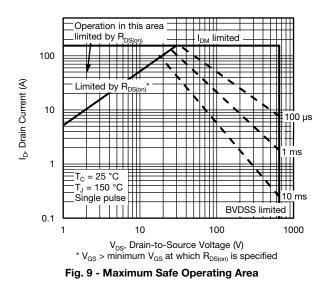


Fig. 8 - Typical Source-Drain Diode Forward Voltage



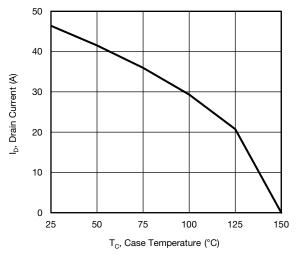


Fig. 10 - Maximum Drain Current vs. Case Temperature

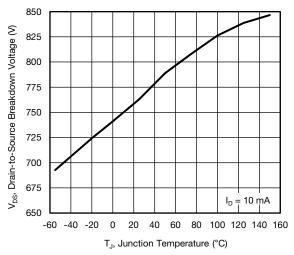


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

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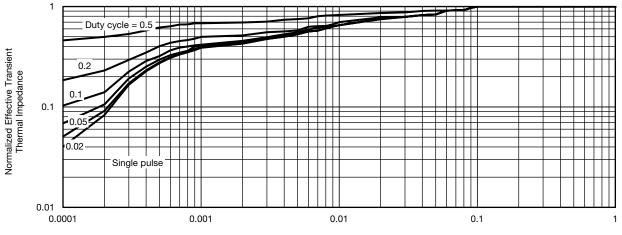
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Pulse Time (s)



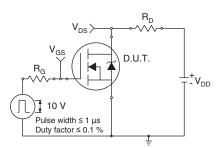


Fig. 13 - Switching Time Test Circuit

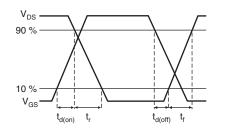


Fig. 14 - Switching Time Waveforms

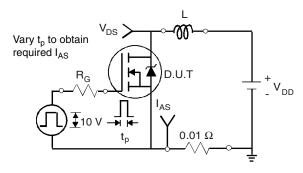


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

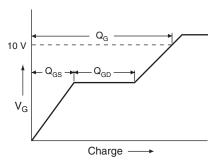
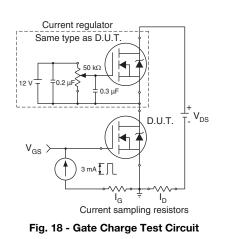


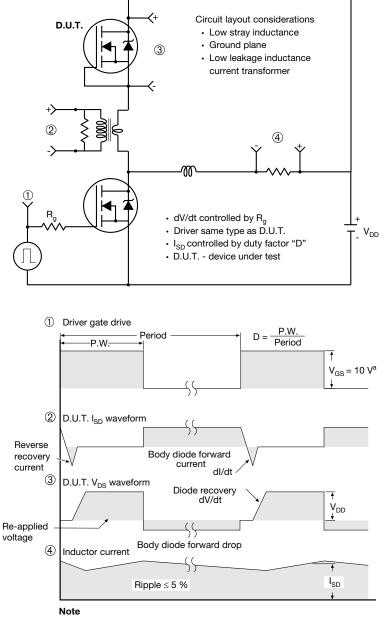
Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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